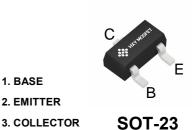
1. BASE 2. EMITTER

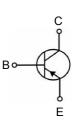
Features

Driver Transistors



Package Marking and Ordering Information

| Product ID | Pack | Marking | Qty(PCS) |
|-------------|--------|---------|----------|
| MMBTA55LT1G | SOT-23 | 2H | 3000 |



Maximum Ratings (Ta=25°C unless otherwise noted)

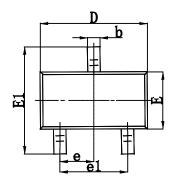
| <u>_</u> ` | | | |
|------------|---|------------------|------|
| Symbol | Parameter | Value | Unit |
| Vсво | Collector-Base Voltage | -60 | V |
| Vceo | Collector-Emitter Voltage | -60 | V |
| VEBO | Emitter-Base Voltage | -4 | V |
| lc | Collector Current | -500 | mA |
| Pc | Collector Power Dissipation | 225 | mW |
| Rөja | Thermal Resistance From Junction To Ambient | 556 | °C/W |
| TJ,Tstg | Operation Junction and Storage Temperature Range | <i>-</i> 55∼+150 | °C |

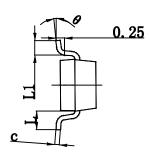
Electrical Characteristics(Ta=25°C unless otherwise specified)

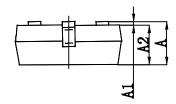
| Parameter | Symbol | Test conditions | Min | Max | Unit |
|--------------------------------------|----------------------|---|-----|-------|------|
| Collector-base breakdown voltage | V _{(BR)CBO} | I _C =-100μA, I _E =0 | -60 | | V |
| Collector-emitter breakdown voltage | V _{(BR)CEO} | I _C =-1mA, I _B =0 | -60 | | V |
| Emitter-base breakdown voltage | V _{(BR)EBO} | I _E =-100μA, I _C =0 | -4 | | V |
| Collector cut-off current | I _{CBO} | V _{CB} =-60V, I _E =0 | | -0.1 | μA |
| Collector cut-off current | I _{CEO} | V _{CE} =-60V, I _B =0 | | -0.1 | μA |
| | h _{FE(1)} | V _{CE} =-1V, I _C =-10mA | 100 | 400 | |
| DC current gain | h _{FE(2)} | V _{CE} =-1V, I _C =-100mA | 100 | | |
| Collector-emitter saturation voltage | V _{CE(sat)} | I _C =-100mA, I _B =-10mA | | -0.25 | V |
| Base-emitter voltage | V_{BE} | V _{CE} =-1V, I _C =-100mA | | -1.2 | V |
| Transition frequency | f⊤ | V _{CE} =-1V,I _C =-100mA, f=100MHz | 50 | | MHz |



SOT-23 Package Outline Dimensions

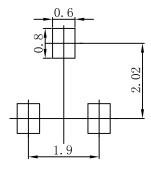






| Symbol | Dimensions In Millimeters | | Dimensions In Inches | | |
|--------|---------------------------|-------|----------------------|-------|--|
| | Min | Max | Min | Max | |
| Α | 0.900 | 1.150 | 0.035 | 0.045 | |
| A1 | 0.000 | 0.100 | 0.000 | 0.004 | |
| A2 | 0.900 | 1.050 | 0.035 | 0.041 | |
| b | 0.300 | 0.500 | 0.012 | 0.020 | |
| С | 0.080 | 0.150 | 0.003 | 0.006 | |
| D | 2.800 | 3.000 | 0.110 | 0.118 | |
| E | 1.200 | 1.400 | 0.047 | 0.055 | |
| E1 | 2.250 | 2.550 | 0.089 | 0.100 | |
| е | 0.950 TYP | | 0.037 TYP | | |
| e1 | 1.800 | 2.000 | 0.071 | 0.079 | |
| L | 0.550 REF | | 0.022 REF | | |
| L1 | 0.300 | 0.500 | 0.012 | 0.020 | |
| θ | 0° | 8° | 0° | 8° | |

SOT-23 Suggested Pad Layout



- 1.Controlling dimension:in millimeters. 2.General tolerance:± 0.05mm.
- 3. The pad layout is for reference purposes only.



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